01-18-01

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Randhir P.S. Thakur et al.

Title:

HIGH PRESSURE ANNEALS OF INTEGRATED CIRCUIT STRUCTURES

Attorney Docket No.:

303.275US2

PATENT APPLICATION TRANSMITTAL

BOX PATENT APPLICATION

Commissioner for Patents Washington, D.C. 20231

We are transmitting herewith the following attached items and information (as indicated with an "X"):

Return postcard. X

- **DIVISIONAL** of prior Patent Application No. <u>08/790,279</u> (under 37 CFR § 1.53(b)) comprising: X
 - Specification (<u>30</u> pgs, including claims numbered <u>1</u> through <u>71</u> and a <u>1</u> page Abstract).
 - Formal Drawing(s) (11 sheets). X
 - Copy of signed Combined Declaration and Power of Attorney (3 pgs) from prior application. X
 - Incorporation by Reference: The entire disclosure of the prior application, from which a copy of the oath or declaration is supplied herewith, is considered as being part of the disclosure of the accompanying application and is hereby incorporated by reference therein.
 - Check in the amount of \$710.00 to pay the filing fee.
 - Prior application is assigned of record to Micron Technology, Inc. .
 - Information Disclosure Statement (1 pgs), Form 1449 (1 pgs). References NOT enclosed, cited in prior application.
 - Preliminary Amendment (2 pgs).

The filing fee has been calculated below as follows:

	No. Filed	No. Extra	Rate	Fee
TOTAL CLAIMS	4 - 20 =	0	x 18 =	\$0.00
INDEPENDENT CLAIMS	1 - 3 =	0	x 80 =	\$0.00
[] MULTIPLE DEPENDENT CLAIMS PRESENTED				\$0.00
BASIC FEE				\$710.00
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